

## Reliability Monitoring Results

Quarters: Q1/2024 to Q4/2024

Based on structural similarity

Supplier		User Part Number				
Nexperia B.V.		74ALVCH16244DGG				
<b>Part Description:</b> 16-bit buffer/line driver with bus hold (3-state)						
Function Family: ALVC Process family: Sub micron Package family: TSSOP						
JESD47 Test	Test Conditions	Duration	# Lots	# Quantity	# Rejects	
# 1 <b>TEST</b> Pre- and Post-Stress Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below	
# 2 <b>PC</b> Preconditioning	JESD22-A113 MSL 1	N/A	1177	93752	0	
# 5a <b>HTOL EFR</b> High Temperature Operating Life Extrinsic	JESD22-A108 Tj = 150°C V <sub>CCMAX</sub> ≤ V ≤ 1.2*V <sub>CCMAX</sub>	48 hours or 168 hours	140	36653	0	
# 5b <b>HTOL IFR</b> High Temperature Operating Life Intrinsic	JESD22-A108 Tj = 150°C V <sub>CCMAX</sub> ≤ V ≤ 1.2*V <sub>CCMAX</sub>	≥500 hours	97	7681	0	
# 7 <b>TC</b> Temperature Cycling	JESD22-A104 -65 °C to 150°C	≥500 cycles	617	47928	0	
# 9 <b>uHAST / HAST</b> unbiased or biased High Accelerated Stress Test	JESD22-A101 Tamb = 130 °C, RH = 85%, V = V <sub>CCMAX</sub>	96 hours	595	45824	0	

### Calculation of PPM, FIT and MTTF

Test considered for PPM calculation: High Temperature Operating LifeTest Extrinsic (HTOL EFR, Test # 5a above)

Test considered for FIT and MTTF calculations: High Temperature Operating LifeTest Intrinsic (HTOL IFR, Test # 5b above)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Product Family	Package Family	Quantity	Rejects	Extrinsic Failure Rate (PPM)	Intrinsic Failure Rate (FIT)	MTTF (hrs)
ALVC	TSSOP	7681	0	26	0.5	2.26 E+09